PALM Intranet

Application Number [　　　　　　] Submit

IDS Flag Clearance for Application 10811350

IDS Information

Content	Mailroom Date	Entry Number	IDS Review	Last Modified	Reviewer
M844	2005-07-01	11	Y ☑	2006-04-25 14:50:26.0	DNhu
M844	2005-02-02	9	Y ☑	2006-04-25 14:50:26.0	DNhu
Update					

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	17381	LED and light and emitter and device	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 14:23
L2	352	LED and light and emitter and device and (silicon adj carbide)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 14:23
L3	3	LED and light and emitter and device and (silicon adj carbide) and etch and etching and aqueous	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:47
L4	1	LED and light and emitter and device and (silicon adj carbide) and (aqueous adj etch)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 14:32
L5	10	LED and light and emitter and device and (aqueous adj etch)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 14:36
L6	20	10/659241	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 14:37
L7	20	6 and (LED or light or emitter or device or silicon or carbide or etch or etching or aqueous or portion or damage or damaged or KOH or carbon or KFeCN or substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 14:49
L8	2	("4966862").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 14:49

L9	2	8 and (LED or light or emitter or device or silicon or carbide or etch or etching or aqueous or portion or damage or damaged or KOH or carbon or KFeCN or substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 14:54
L10	26	2002/0123164	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 14:51
L11	26	10 and (LED or light or emitter or device or silicon or carbide or etch or etching or aqueous or portion or damage or damaged or KOH or carbon or KFeCN or substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 14:59
L12	2	("5912477").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 14:59
L13	2	12 and (LED or light or emitter or device or silicon or carbide or etch or etching or aqueous or portion or damage or damaged or KOH or carbon or KFeCN or substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:01
L14	2	("6214107").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:01
L15	2	14 and (LED or light or emitter or device or silicon or carbide or etch or etching or aqueous or portion or damage or damaged or KOH or carbon or KFeCN or substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:05
L16	2	("5825385").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:05

L17	2	16 and (LED or light or emitter or device or silicon or carbide or etch or etching or aqueous or portion or damage or damaged or KOH or carbon or KFeCN or substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:09
L18	2	("6893892").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:09
L19	2	18 and (LED or light or emitter or device or silicon or carbide or etch or etching or aqueous or portion or damage or damaged or KOH or carbon or KFeCN or substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 16:02
L20	2	("6885033").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:14
L21	2	20 and (LED or light or emitter or device or silicon or carbide or etch or etching or aqueous or portion or damage or damaged or KOH or carbon or KFeCN or substrate or parameter)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:19
L22	1	"6635503".PN.	USPAT; USOCR	OR	OFF	2006/08/02 15:17
L23	1	"6245259".PN.	USPAT; USOCR	OR	OFF	2006/08/02 15:17
L24	1	"6201262".PN.	USPAT; USOCR	OR	OFF	2006/08/02 15:18
L25	1	"6187606".PN.	USPAT; USOCR	OR	OFF	2006/08/02 15:18
L26	1	"6120600".PN.	USPAT; USOCR	OR	OFF	2006/08/02 15:18
L27	1	"5912477".PN.	USPAT; USOCR	OR	OFF	2006/08/02 15:18
L28	1	"5739554".PN.	USPAT; USOCR	OR	OFF	2006/08/02 15:19

EAST Search History

L29		1	22 and (LED or light or emitter or device or silicon or carbide or etch or etching or aqueous or portion or damage or damaged or KOH or carbon or KFeCN or substrate or parameter)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:22
L30		2	("6201262").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:22
L31		2	30 and (LED or light or emitter or device or silicon or carbide or etch or etching or aqueous or portion or damage or damaged or KOH or carbon or KFeCN or substrate or parameter)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:24
L32		2	("6187606").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:24
L33		2	32 and (LED or light or emitter or device or silicon or carbide or etch or etching or aqueous or portion or damage or damaged or KOH or carbon or KFeCN or substrate or parameter)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:24
L34		2	("6120600").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:24
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L37	2	36 and (LED or light or emitter or device or silicon or carbide or etch or etching or aqueous or portion or damage or damaged or KOH or carbon or KFeCN or substrate or parameter)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:26
L38	2	("5631190").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:26
L39	2	38 and (LED or light or emitter or device or silicon or carbide or etch or etching or aqueous or portion or damage or damaged or KOH or carbon or KFeCN or substrate or parameter)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:28
L40	2	("5604135").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:28
L41	2	40 and (LED or light or emitter or device or silicon or carbide or etch or etching or aqueous or portion or damage or damaged or KOH or carbon or KFeCN or substrate or parameter)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:29
L42	2	("5523589").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:29
L43	2	42 and (LED or light or emitter or device or silicon or carbide or etch or etching or aqueous or portion or damage or damaged or KOH or carbon or KFeCN or substrate or parameter)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:30
L44	2	("5393993").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:30

L45	2	44 and (LED or light or emitter or device or silicon or carbide or etch or etching or aqueous or portion or damage or damaged or KOH or carbon or KFeCN or substrate or parameter)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:32
L46	2	("5338944").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:32
L47	2	("5210051").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:32
L48	2	47 and (LED or light or emitter or device or silicon or carbide or etch or etching or aqueous or portion or damage or damaged or KOH or carbon or KFeCN or substrate or parameter)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:33
L49	2	("5027168").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:33
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L51	26	2002/0123164	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:34
L52	33	2003/0006418	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:35

L53		33	52 and (LED or light or emitter or device or silicon or carbide or etch or etching or aqueous or portion or damage or damaged or KOH or carbon or KFeCN or substrate or parameter)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:39
L54		8	2004/0056260	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:38
L55		0	2001/040245	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:39
L56		2	("6084175").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:39
L57		2	56 and (LED or light or emitter or device or silicon or carbide or etch or etching or aqueous or portion or damage or damaged or KOH or carbon or KFeCN or substrate or parameter)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:43
L58		2	("5825385").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:43
L59		2	58 and (LED or light or emitter or device or silicon or carbide or etch or etching or aqueous or portion or damage or damaged or KOH or carbon or KFeCN or substrate or parameter)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:47
L60		1	LED and light and emitter and device and (silicon adj carbide) and (aqueous adj etching)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:48

L61	0	LED and light and emitter and device and (silicon adj carbide) and KOH and etch and aqueous	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:49
L62	6	LED and light and emitter and device and (silicon adj carbide) and KOH and etch	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 15:49
L63	576	438/20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 16:05
L64	456	438/21	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 16:05
L65	438	438/25	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 16:06
L66	53	438/983	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 16:06
L67	2111	438/745	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 16:06
L68	2779	438/706	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 16:06

L69	1107	438/712		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 16:06
L70	330	438/708		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 16:06
L71	292	438/40		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 16:06
L72	249	438/673		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/02 16:06